

In re application of

RICHARD W. ARNOLD ET AL.

Serial No. 09/164,580 (TI-22561)

Filed October 1, 1998

For: KNOWN GOOD DIE USING EXISTING PROCESS INFRASTRUCTURE

Art Unit 2822

Examiner J. Mitchell

Commissioner for Patents Washington, D. C. 20231

Sir:

AMENDMENT UNDER 37 C.F.R. 1.116

In response to the Office action dated February 25, 2002, please amend the above identified application as follows:

In the claims:

Amend claim 30 as follows:

30. (Amended) An apparatus adaptable for the testing of semiconductor devices comprising:

a package, wherein said package has a package lid having a lower surface adapted for receiving said semiconductor device, said semiconductor device having an upper surface, and a package base having an upper surface;